

N-channel 30 V, 7.5 m Ω logic level MOSFET in LFPAK33 using NextPowerS3 Technology

11 August 2015

Product data sheet

1. General description

Logic level gate drive N-channel enhancement mode MOSFET in LFPAK33 package. NextPowerS3 portfolio utilising Nexperia's unique "SchottkyPlus" technology delivers high efficiency, low spiking performance usually associated with MOSFETs with an integrated Schottky or Schottky-like diode but without problematic high leakage current. NextPowerS3 is particularly suited to high efficiency applications at high switching frequencies.

2. Features and benefits

- Ultra low Q_G, Q_{GD} and Q_{OSS} for high system efficiency, especially at higher switching frequencies
- Superfast switching with soft-recovery; s-factor > 1
- Low spiking and ringing for low EMI designs
- Unique "SchottkyPlus" technology; Schottky-like performance with < 1 µA leakage at 25 °C
- Optimised for 4.5 V gate drive
- Low parasitic inductance and resistance
- High reliability clip bonded and solder die attach Mini Power SO8 package; no glue, no wire bonds, qualified to 175 °C
- Exposed leads for optimal visual solder inspection

3. Applications

- On-board DC-to-DC solutions for server and telecommunications
- Secondary-side synchronous rectification in telecommunication applications
- Voltage regulator modules (VRM)
- Point-of-Load (POL) modules
- Power delivery for V-core, ASIC, DDR, GPU, VGA and system components
- Brushed and brushless motor control

4. Quick reference data

Table 1. Qui	ck reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C	-	-	30	V
I _D	drain current	T _{mb} = 25 °C; V _{GS} = 10 V; <u>Fig. 2</u>	-	-	57	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>	-	-	45	W

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Tj	junction temperature		-55	-	175	°C
Static char	acteristics	· · ·				
R _{DSon}	drain-source on-state resistance	V _{GS} = 4.5 V; I _D = 10 A; T _j = 25 °C; Fig. 10	-	8.2	10.3	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _j = 25 °C; Fig. 10	-	6.3	7.6	mΩ
Dynamic cl	haracteristics	· · · ·	ł			
Q _{GD}	gate-drain charge	V _{GS} = 4.5 V; I _D = 15 A; V _{DS} = 15 V; Fig. 12; Fig. 13	-	1.7	2.5	nC
Q _{G(tot)}	total gate charge	V _{GS} = 4.5 V; I _D = 15 A; V _{DS} = 15 V; Fig. 12; Fig. 13	-	5.8	8.8	nC
Source-dra	in diode		I			
S	softness factor	$I_{S} = 15 \text{ A}; V_{GS} = 0 \text{ V}; \text{ dI}_{S}/\text{dt} = -100 \text{ A}/\mu\text{s};$ $V_{DS} = 15 \text{ V}; \frac{\text{Fig. 16}}{100}$	-	1.2	-	

5. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source		D
2	S	source		
3	S	source	\bigcirc	G-UFT 4
4	G	gate		mbb076 S
mb	D	mounting base; connected to drain	LFPAK33 (SOT1210)	

6. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
PSMN7R5-30MLD	LFPAK33	Plastic single ended surface mounted package (LFPAK33); 8 leads	SOT1210			

7. Marking

Table 4. Marking codes		
Type number	Marking code	
PSMN7R5-30MLD	7D530L	
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8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

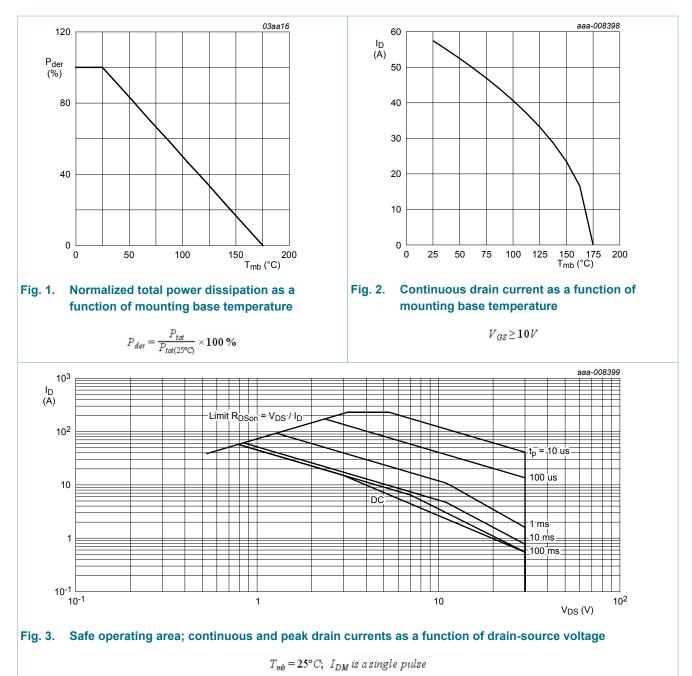
Symbol	Parameter	Conditions		Min	Мах	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	30	V
V _{DGR}	drain-gate voltage	25 °C \leq T _j \leq 175 °C; R _{GS} = 20 k Ω		-	30	V
V _{GS}	gate-source voltage			-20	20	V
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	45	W
ID	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>		-	57	Α
		V _{GS} = 10 V; T _{mb} = 100 °C; <u>Fig. 2</u>		-	40	Α
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^\circ C$; Fig. 3		-	230	Α
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
T _{sld(M)}	peak soldering temperature			-	260	°C
Source-dra	in diode					
I _S	source current	T _{mb} = 25 °C		-	38	А
I _{SM}	peak source current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^\circ C$		-	230	А
Avalanche	ruggedness					
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	$\label{eq:VGS} \begin{split} V_{GS} &= 10 \text{ V}; \text{T}_{j(\text{init})} = 25 ^{\circ}\text{C}; \text{I}_{D} = 15 \text{ A}; \\ V_{sup} &\leq 30 \text{ V}; \text{R}_{GS} = 50 \Omega; \text{ unclamped}; \\ \text{t}_{p} &= 97 \mu\text{s} \end{split}$	[1]	-	28.3	mJ

[1] Protected by 100% test

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9. Thermal characteristics

Table 6. The	ermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. 4	-	3.1	3.32	K/W

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance	<u>Fig. 5</u>	-	57	-	K/W
	from junction to ambient	Fig. 6	-	178	-	K/W

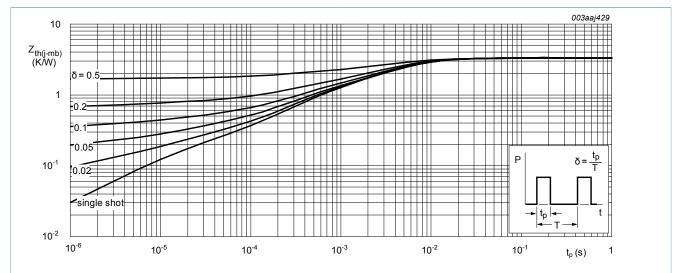
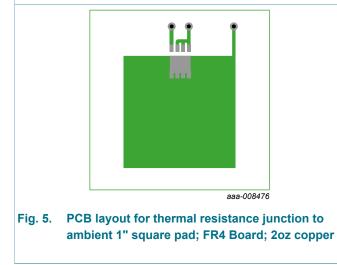


Fig. 4. Transient thermal impedance from junction to mounting base as a function of pulse duration



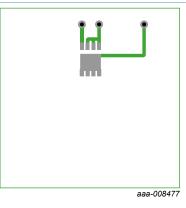


Fig. 6. PCB layout for thermal resistance junction to ambient minimum footprint; FR4 Board; 2oz copper

10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics	· · · ·				
V _{(BR)DSS}	drain-source	I_D = 250 µA; V_{GS} = 0 V; T_j = 25 °C	30	-	-	V
	breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _j = -55 °C	27	-	-	V
V _{GS(th)}	gate-source threshold voltage	I_D = 1 mA; V_{DS} = V_{GS} ; T_j = 25 °C	1.2	1.7	2.2	V

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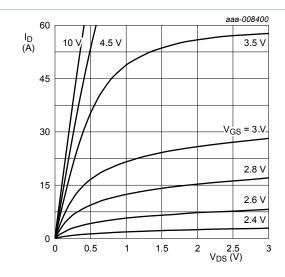
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$\Delta V_{GS(th)} / \Delta T$	gate-source threshold voltage variation with temperature	25 °C ≤ T _j ≤ 150 °C	-	-3.8	-	mV/K
I _{DSS}	drain leakage current	V_{DS} = 24 V; V_{GS} = 0 V; T_j = 25 °C	-	-	1	μA
		V_{DS} = 24 V; V_{GS} = 0 V; T_j = 125 °C	-	0.26	-	μA
I _{GSS}	gate leakage current	V_{GS} = 16 V; V_{DS} = 0 V; T_j = 25 °C	-	-	100	nA
		V_{GS} = -16 V; V_{DS} = 0 V; T_j = 25 °C	-	-	100	nA
R _{DSon}	R _{DSon} drain-source on-state resistance	V_{GS} = 4.5 V; I _D = 10 A; T _j = 25 °C; Fig. 10	-	8.2	10.3	mΩ
		V _{GS} = 4.5 V; I _D = 10 A; T _j = 150 °C; Fig. 11; Fig. 10	-	-	17	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _j = 25 °C; Fig. 10	-	6.3	7.6	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _j = 150 °C; Fig. 11; Fig. 10	-	-	12.5	mΩ
R _G	gate resistance	f = 1 MHz	-	0.25	0.49	Ω
Dynamic cha	aracteristics					
Q _{G(tot)}	total gate charge	I_D = 15 A; V_{DS} = 15 V; V_{GS} = 10 V; Fig. 12; Fig. 13	-	11.3	17	nC
		I_D = 15 A; V_{DS} = 15 V; V_{GS} = 4.5 V; Fig. 12; Fig. 13	-	5.8	8.8	nC
		$I_D = 0 A; V_{DS} = 0 V; V_{GS} = 10 V$	-	10.2	-	nC
Q _{GS}	gate-source charge	I_D = 15 A; V_{DS} = 15 V; V_{GS} = 4.5 V;	-	1.97	-	nC
Q _{GS(th)}	pre-threshold gate- source charge	Fig. 12; Fig. 13	-	1.14	-	nC
Q _{GS(th-pl)}	post-threshold gate- source charge		-	0.83	-	nC
Q _{GD}	gate-drain charge		-	1.7	2.5	nC
V _{GS(pl)}	gate-source plateau voltage	I _D = 15 A; V _{DS} = 15 V; <u>Fig. 12</u> ; <u>Fig. 13</u>	-	2.9	-	V
C _{iss}	input capacitance	V_{DS} = 15 V; V_{GS} = 0 V; f = 1 MHz;	-	655	982	pF
C _{oss}	output capacitance	T _j = 25 °C; <u>Fig. 14</u>	-	578	867	pF
C _{rss}	reverse transfer capacitance		-	50	75	pF
t _{d(on)}	turn-on delay time	V_{DS} = 15 V; R _L = 1 Ω; V _{GS} = 4.5 V;	-	7.1	-	ns
t _r	rise time	$R_{G(ext)} = 5 \Omega$	-	10.4	-	ns
t _{d(off)}	turn-off delay time		-	8.5	-	ns
t _f	fall time		-	5.5	-	ns

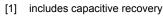
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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Q _{oss}	output charge	V _{GS} = 0 V; V _{DS} = 15 V; f = 1 MHz; T _j = 25 °C		-	11	-	nC
Source-dra	in diode	·					
V _{SD}	source-drain voltage	I_{S} = 10 A; V_{GS} = 0 V; T_{j} = 25 °C; <u>Fig. 15</u>		-	0.82	1.2	V
t _{rr}	reverse recovery time	I_{S} = 15 A; dI_{S}/dt = -100 A/µs; V_{GS} = 0 V;		-	23	46	ns
Q _r	recovered charge	V _{DS} = 15 V; <u>Fig. 16</u>	[1]	-	11	22	nC
t _a	reverse recovery rise time			-	10.2	-	ns
t _b	reverse recovery fall time			-	12.6	-	ns
S	softness factor			-	1.2	-	







 $T_j = 25^{\circ}C$

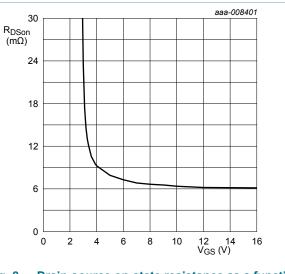
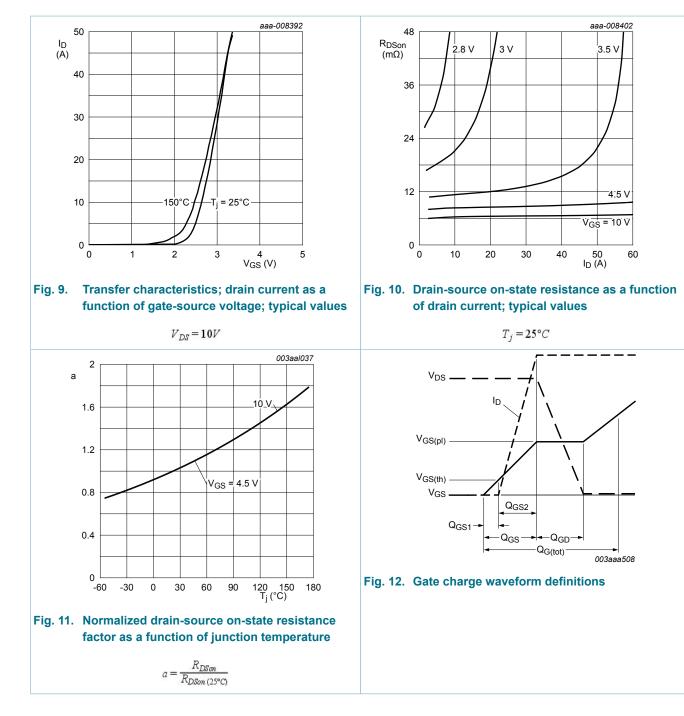


Fig. 8. Drain-source on-state resistance as a function of gate-source voltage; typical values

 $T_j = 25^{\circ}C; I_D = 15A$

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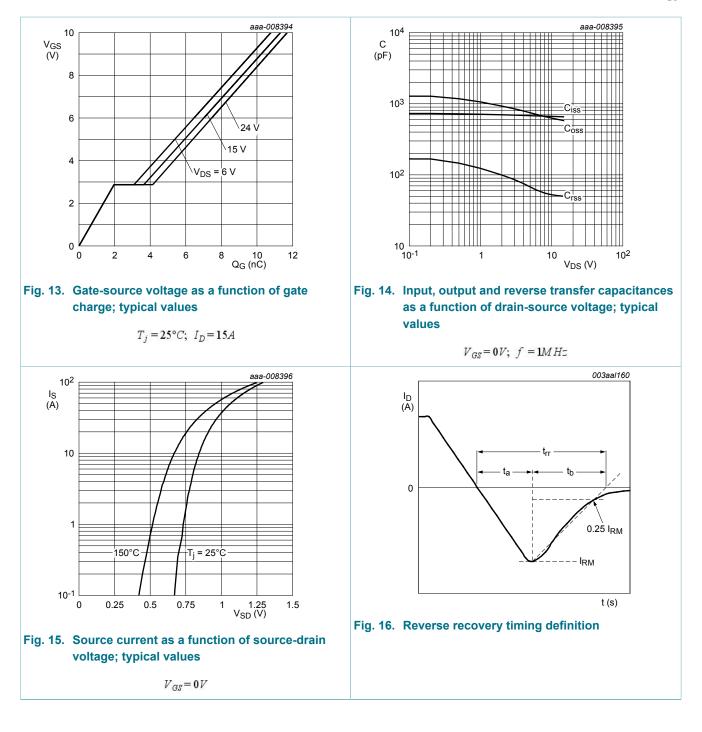
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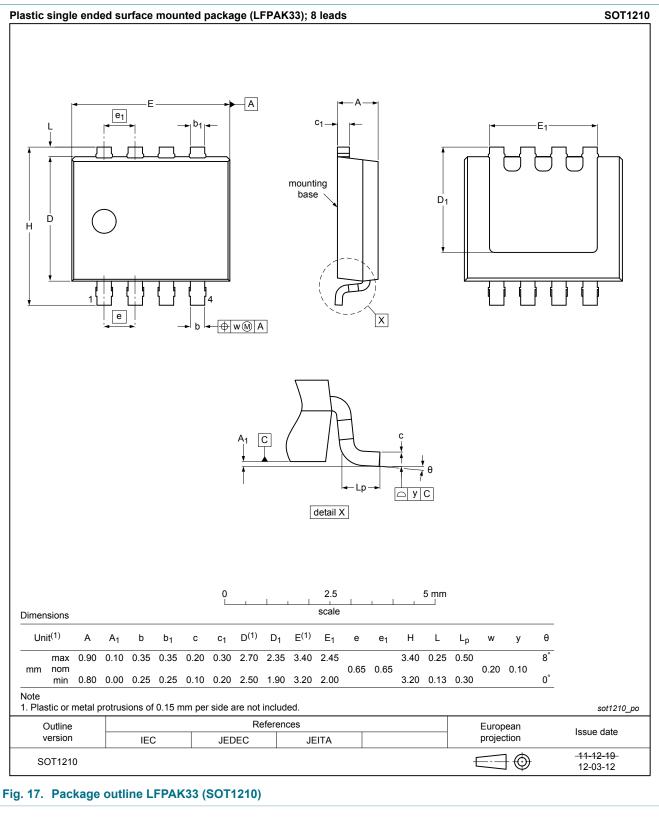
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11. Package outline



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12. Legal information

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